

We claim:

- 1 1. A nonvolatile memory cell, comprising:
  - 2 a high-voltage capacitor;
  - 3 a high-voltage write path coupled to the high-voltage capacitor; and
  - 4 a low-voltage read path coupled to both the high-voltage capacitor and the
  - 5 high-voltage write path;
    - 6 wherein either the high-voltage write path is situated between the low-voltage
    - 7 read path and the high-voltage capacitor or the high-voltage capacitor is situated
    - 8 between the low-voltage read path and the high-voltage write path.
- 1 2. The nonvolatile memory cell of claim 1 wherein the low-voltage read path
- 2 comprises a floating gate transistor.
- 1 3. The nonvolatile memory cell of claim 2 wherein the high-voltage capacitor
- 2 comprises a conductive plate and a first diffusion region, wherein the conductive plate
- 3 is separated from the first diffusion region by an oxide layer and is electrically
- 4 connected to a floating gate of the floating gate transistor.
- 1 4. The nonvolatile memory cell of claim 3 wherein the high-voltage write path
- 2 comprises a conductive plate and a second diffusion region, the conductive plate
- 3 being electrically connected to the conductive plate of the high-voltage capacitor and
- 4 at least a portion of the conductive plate being separated from the second diffusion
- 5 region by a layer of tunnel oxide.
- 1 5. The non-volatile memory cell of claim 2 wherein the floating gate transistor is
- 2 a native floating gate transistor.
- 1 6. The nonvolatile memory cell of claim 2 wherein the low-voltage read path
- 2 further comprises a read transistor.

1 7. The nonvolatile memory cell of claim 6 wherein the floating gate transistor  
2 and the read transistor are serially connected.

1 8. The nonvolatile memory cell of claim 7 wherein a diffusion region of the read  
2 transistor is electrically connected to a diffusion region of the floating gate transistor.

1 9. The nonvolatile memory cell of claim 6 wherein the read transistor is  
2 significantly more resistive than the floating gate transistor when a read current runs  
3 serially through channels of the read transistor and the floating gate transistor.

1 10. A nonvolatile memory cell, comprising:  
2 a high-voltage capacitor;  
3 a high-voltage write path coupled to the high-voltage capacitor; and  
4 a low-voltage read path coupled to both the high-voltage capacitor and the  
5 high voltage write path;  
6 wherein the low-voltage read path includes a native floating gate transistor.

1 11. The nonvolatile memory cell of claim 10 wherein the high-voltage capacitor is  
2 situated between the low-voltage read path and the high-voltage write path.

1 12. The non-volatile memory cell of claim 10 wherein the high-voltage write path  
2 is situated between the low-voltage read path and the high-voltage capacitor.

1 13. The nonvolatile memory cell of claim 10 wherein the high-voltage capacitor  
2 comprises a conductive plate and a first diffusion region, wherein the conductive plate  
3 is separated from the first diffusion region by an oxide layer and is electrically  
4 connected to a floating gate of the floating gate transistor.

1 14. The nonvolatile memory cell of claim 13 wherein the low-voltage read path  
2 comprises a conductive plate and a second diffusion region, the conductive plate  
3 being electrically connected to the conductive plate of the high-voltage capacitor and

4 at least a portion of the conductive plate being separated from the second diffusion  
5 region by a layer of tunnel oxide.

1 15. The nonvolatile memory cell of claim 10 wherein the low-voltage read path  
2 also includes a read transistor.

1 16. The nonvolatile memory cell of claim 15 wherein the floating gate transistor  
2 and the read transistor are serially connected.

1 17. The nonvolatile memory cell of claim 16 wherein a diffusion region of the  
2 read transistor is electrically connected to a diffusion region of the floating gate  
3 transistor.

1 18. The nonvolatile memory cell of claim 16 wherein the read transistor is  
2 significantly more resistive than the floating gate transistor when a read current runs  
3 serially through channels of the read transistor and the floating gate transistor.

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5 19. A nonvolatile memory cell fabricated on a substrate, comprising:  
6 a high-voltage capacitor having a first diffusion region in the substrate;  
7 a high-voltage write path having at least a second diffusion region in the  
8 substrate; and  
9 a low-voltage read path having at least a third diffusion region in the substrate;  
10 wherein the second diffusion region is situated between the first diffusion  
11 region and the third diffusion region, or the first diffusion region is situated between  
12 the second diffusion region and the third diffusion region.

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14 20. The nonvolatile memory cell of claim 19, further comprising a floating gate  
15 over the first diffusion region, the second diffusion region and the third diffusion  
16 region.